i. 🛛

j. 🛛

Claim(s) as Classified Below

Abstract of the Disclosure

UTILITY PATENT APPLICATION TRANSMITTAL (Large Entity)

(Only for new nonprovisional applications under 37 CFR 1.53(b))

Docket No. 12688A

Total Pages in this Submission

<u>π</u> 10 1	<u>HE ASSISTANT COMMISSIO</u>						
2	Box Patent Applica Washington, D.C. 2						
Transmitted herewith for filing under			andination for an				
invention entitled:	55 0.5.C. 111(a) and 57 C.F.F	T. 1.55(b) is a new utility patent a	application for an				
METHOD FOR CLEANING SEM	ICONDUCTOR WAFER AFT	ER CHEMICAL	4.9				
MECHANICAL POLISHING CO	PPER WIRING	ER CHEMICAL					
			50				
and invented by:			60				
HIDEMITSU AOKI, et al.			or =				
If a CONTINUATION APPLICATION	, check appropriate box and s	supply the requisite information:					
☐ Continuation Divisional	☐ Continuation-in-part	(CIP) of prior application No.:	09/313,027				
Which is a:							
☐ Continuation ☐ Divisional	☐ Continuation-in-part	(CIP) of prior application No.:					
Which is a:							
🔲 Continuation 🔲 Divisional	☐ Continuation-in-part	(CIP) of prior application No.:					
Enclosed are:							
ij e	Application Eleme	ents					
1. 🗵 Filing fee as calculated a	nd transmitted as described be	elow					
2. 🗵 Specification having	40 pages	and including the following:					
a. 🗵 Descriptive Title of t	ne Invention						
	Related Applications (if applied	cable)					
	Reference to Sequence Listing, a Table, or a Computer Program Listing Appendix						
	Background of the Invention						
	Brief Summary of the Invention						
*	Brief Description of the Drawings (if filed)						
h. 🗵 Detailed Description	5 (,						

UTILITY PATENT APPLICATION TRANSMITTAL (Large Entity)

(Only for new nonprovisional applications under 37 CFR 1.53(b))

Docket No. 12688A

Total Pages in this Submission

Application Elements (Continued)

3	3. [2	X	Drawing(s) (when necessary as prescribed by 35 USC 113)					
		a.						
		b.	☐ Informal Number of Sheets					
4	. [2	X	Oath or Declaration					
		a.	☐ Newly executed (original or copy) ☐ Unexecuted					
		b.	☑ Copy from a prior application (37 CFR 1.63(d)) (for continuation/divisional application only)					
		C.						
	•	d. DELETION OF INVENTOR(S) Signed statement attached deleting inventor(s) named in the prior application, see 37 C.F.R. 1.63(d)(2) and 1.33(b).						
5 6	. [Incorporation By Reference (usable if Box 4b is checked) The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied under Box 4b, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein.					
6	. []	CD ROM or CD-R in duplicate, large table or Computer Program (Appendix)					
7	. []	Application Data Sheet (See 37 CFR 1.76)					
8	. [ב	Nucleotide and/or Amino Acid Sequence Submission (if applicable, all must be included)					
Wind	8	a.	☐ Computer Readable Form (CRF)					
	- 1	b.	Specification Sequence Listing on:					
de B			i. D CD-ROM or CD-R (2 copies); or					
Month Spin			ii. 🔲 Paper					
No.	. (C.	Statement(s) Verifying Identical Paper and Computer Readable Copy					
Accompanying Application Parts								
9.	, ,]	Assignment Papers (cover sheet & document(s))					
10.	. ,]						
11.]	English Translation Document (if applicable)					
12.	×	<	Information Disclosure Statement/PTO-1449 Copies of IDS Citations					
13.	X		· · · · · · · · · · · · · · · · · · ·					
14.	X	9						
15.]						
16.	X	_	Certificate of Mailing					
			☐ First Class ☒ Express Mail (Specify Label No.): EV-010-535-685-US					

UTILITY PATENT APPLICATION TRANSMITTAL (Large Entity)

(Only for new nonprovisional applications under 37 CFR 1.53(b))

Docket No. 12688A

Total Pages in this Submission

Accompanying Application Parts (Continued)

17.	Z	Additional Enclosures (please identify below):				
		Assignee: NEC Corporation				
		Tokyo, Japan				
-						
9						
¥ .		·				
-						
		Request That Application Not Be Published Pursuant To 35 U.S.C. 122(b)(2)				
18.		Pursuant to 35 U.S.C. 122(b)(2), Applicant hereby requests that this patent application not be published pursuant to 35 U.S.C. 122(b)(1). Applicant hereby certifies that the invention disclosed in this application has not and will not be the subject of an application filed in another country, or under a multilateral international agreement, that requires publication of applications 18 months after filing of the application.				
		Warning				
		warmiy				
	*	An applicant who makes a request not to publish, but who subsequently files in a foreign country or under a multilateral international agreement specified in 35 U.S.C. 122(b)(2)(B)(i), must notify the Director of such filing not later than 45 days after the date of the filing of such foreign or international application. A failure of the applicant to provide such notice				

who makes a request not to publish, but who subsequently files in a foreign country or under a multilateral international agreement specified in 35 U.S.C. 122(b)(2)(B)(i), must notify the Director of such filing not later than 45 days after the date of the filing of such foreign or international application. A failure of the applicant to provide such notice within the prescribed period shall result in the application being regarded as abandoned, unless it is shown to the satisfaction of the Director that the delay in submitting the notice was unintentional.

UTILITY PATENT APPLICATION TRANSMITTAL (Large Entity)

(Only for new nonprovisional applications under 37 CFR 1.53(b))

Docket No. 12688A

Total Pages in this Submission 4

Fee Calculation and Transmittal

CLAIMS AS FILED						
For	#Filed	#Allowed	#Extra		Rate	Fee
Total Claims	42	- 20 =	22	x	\$18.00	\$396.00
Indep. Claims	4	- 3 =	1	x	\$84.00	\$84.00
Multiple Dependent Claims (check if applicable)						\$280.00
BASIC FEE					\$740.00	
OTHER FEE (specify	OTHER FEE (specify purpose) \$0.00					\$0.00
					TOTAL FILING FEE	\$1,500.00
A check in the amount of \$1,500.00 to cover the filing fee is enclosed. The Commissioner is hereby authorized to charge and credit Deposit Account No. 19-1013 SSMP as described below. A duplicate copy of this sheet is enclosed. Charge the amount of as filing fee. Credit any overpayment. Charge any additional filing fees required under 37 C.F.R. 1.16 and 1.17. Charge the issue fee set in 37 C.F.R. 1.18 at the mailing of the Notice of Allowarice, pursuant to 37 C.F.R. 1.311(b). Signature Mark J. Cohen Registration No. 32,211 Scully, Scott, Murphy & Presser 400 Garden City Plaza Garden City, New York 11530						

CERTIFICATE OF MAILING BY "EXPRESS MAIL" (37 CFR 1.10) Applicant(s): HIDEMITSU AOKI, et al. Docket No. 12688A							
Serial No. unassigned	Filing Date herewith	Examiner unassigned	Group Art Unit 1746				
Invention: METHOD FOR CLEANING SEMICONDUCTOR WAFER AFTER CHEMICAL MECHANICAL POLISHING COPPER WIRING							
I hereby certify that the following correspondence:							
NEW DIVISIONAL							
· · · · · · · · · · · · · · · · · · ·	(Identify type of correspondence)						
is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 in an envelope addressed to: The Assistant Commissioner for Patents, Washington, D 20231 on							
		(Signature of Person Mailing EV-010-535-68	diling Correspondence) Correspondence) 85-US				
is being deposited with 37 CFR 1.10 in an enver	the United States Postal Service elope addressed to: The Assistants, 2002	Michelle Mus (Typed on Printed Name of Person Mailing EV-010-535-68	Stafa diling Correspondence) Correspondence)				

Note: Each paper must have its own certificate of mailing.